

IN THE CLAIMS

The following includes the entire set of pending claims with mark-ups.

Please amend Claims 1, 9, and 10.

Please add Claims 11-13.

1. (currently amended) A conductive contact member for establishing a temporary electric contact by being applied under a resilient force to an object to be contacted that includes solid solder, the conductive contact member comprising a layer of highly electrically conductive material resistant to solder deposition and ~~essentially~~ consisting of gold containing a small amount of silver, the layer being formed at least over a conductive contact part of said conductive contact member so that said conductive contact part of said conductive contact member may not be contaminated by deposition of solder from said object to be contacted.
2. (original) A conductive contact member according to claim 1, wherein said layer is formed by plating.
3. (canceled)
4. (previously presented) A conductive contact member according to claim 1, wherein silver is added to gold by 0.01% to 8%.
5. (previously presented) A conductive contact member according to claim 1, wherein said conductive contact member is selected from the group consisting of a coil, needle member having a pointed end, and rod member having a flat end.
6. (original) A conductive contact member according to claim 1, wherein said conductive contact member is made of steel.
7. (original) A conductive contact member according to claim 1, wherein said conductive contact member is in the form of a compression coil spring, and said solder resistant layer is formed around a coil wire forming said coil spring.

8. (original) A conductive contact member according to claim 1, wherein said conductive contact member is in the form of a compression coil spring having a contact part consisting of closely wound turns of a coil wire, and said solder resistant layer is formed over an outer surface of said closely wound turns of the coil wire.

9. (currently amended) A conductive contact member of a contact probe for establishing a temporary electric contact by being applied under a resilient force to an object to be contacted that includes solid solder, the conductive contact member comprising a layer of highly electrically conductive material resistant to solder deposition and ~~essentially~~ consisting of an alloy of gold added with silver, the layer being formed at least over a conductive contact part of said conductive contact member so that said conductive contact part of said conductive contact member may not be contaminated by deposition of solder from said object to be contacted.

10. (currently amended) A conductive contact member of a contact probe for establishing a temporary electric contact by being applied under a resilient force to an object to be contacted that includes solid solder, the conductive contact member comprising a layer of highly electrically conductive material resistant to solder deposition and ~~essentially~~ consisting of a homogeneous mixture of gold added with silver, the layer being formed at least over a conductive contact part of said conductive contact member so that said conductive contact part of said conductive contact member may not be contaminated by deposition of solder from said object to be contacted.

11. (new) A conductive contact member according to claim 1, wherein an amount of silver added to gold is between 0.01% and 5%.

12. (new) A conductive contact member according to claim 9, wherein an amount of silver added to gold is between 0.01% and 5%.

13. (new) A conductive contact member according to claim 10, wherein an amount of silver added to gold is between 0.01% and 5%.